

# AND113(P) Series

# Standard LED

## T-1 3/4 Package (5 mm)

#### **Features**

- Low power requirement
- Stand-off or flush-mount
- All plastic molded lens
- Choice of 3 colors: GaP-Red; GaP-Green; GaAsP-Yellow

### Optical Characteristics (T = 25°C)

Part Number	Color		Lens Desc.	Lumi	rial nous ry (mcd)	Test Condition (I <sub>E</sub> -mA)	Viewing Angle 2θ1/2	
	LED	Lens		Min.	Тур.	(15 11174)	(deg)	
AND113G/GP	Green	Green	Clear	20	50	10	30	
AND113R/RP	Red	Red	Clear	5	18	10	30	
AND113S	Red	Red	Clear	50	150	10	30	
AND113Y/YP	Yellow	Yellow	Clear	20	50	10	30	

## Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Characteristics	Symbol		Rating		Unit		
Cital acteristics	Symbol	Red	Green	Yellow	Oille		
Forward Current AND113(P) AND113S	I <sub>F</sub>	25 30	25	30	mA		
Reverse Voltage	V <sub>R</sub>	5	5	5	V		
Power AND113(P) Dissipation AND113S	P <sub>D</sub>	120 105	105 -	105 -	mW		
Operating Temperature	T <sub>Opr</sub>		-40 to +85		°C		
Storage Temperature Range	T <sub>Stg</sub>		-40 to +85				

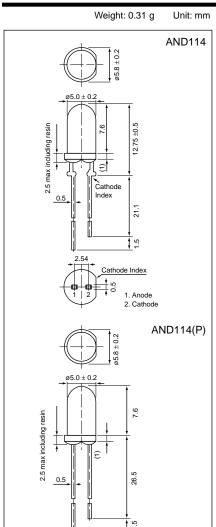
## Electro-Optical Characteristics $(T_A = 25^{\circ}C)$

Ob anastanistica	Cumb al	Test	Red			Green			Yellow			l la it
Characteristics	Symbol	Condition	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	_	2.0	2.5	_	2.1	2.5	_	2.1	2.5	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	_	_	10	_	-	10	μA
Peak Emission Wavelength AND113(P) AND113S	λρ	I <sub>F</sub> = 15mA	_ _	700 625	_ _	_ _	565 -	_ _	_ _	590 –	- -	nm
Spectral Line Half Width AND113(P) AND113S	λ	I <sub>F</sub> = 15mA	_ _	45 45	_ _	_ _	30 -	_ _	_ _	35 -	_ _	nm

#### Precaution

- 1. Soldering temperature: 260°C max; Soldering time: 3 sec. max; Soldering portion of lead: up to 2 mm from the body of the device.
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.





# AND114(P) Series

## Standard LED T-1 3/4 Package (5 mm)

#### **Features**

- Low power requirement
- · Stand-off or flush-mount
- All plastic molded lens
- Choice of 3 colors: GaP-Red; GaP-Green; GaAsP-Yellow

#### Optical Characteristics (T = 25°C)

Part	Color		Lens		minous y (mcd)	Test Condition	Viewing Angle
Number	LED	Lens	Desc.	Min.	Тур.	(I <sub>F</sub> -mA)	2θ1/2 (deg)
AND114G/GP	Green	Green	Diffused	5	18	10	60
AND114R/RP	Red	Red	Diffused	2	5	10	60
AND114S	Red	Red	Diffused	20	50	10	60
AND114Y/YP	Yellow	Yellow	Diffused	5	18	10	60

#### Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Characteristics	Symbol		Rating		Unit
Citatacteristics	Symbol	Red	Green	Yellow	Onit
Forward Current AND114(P) AND114S	I <sub>F</sub>	25 30	25 -	30 -	mA
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Power Dissipation AND114(P) AND114S	P <sub>D</sub>	120 105	105 -	105 -	mW
Operating Temperature	T <sub>Opr</sub>		-40 to +85	•	°C
Storage Temperature Range	T <sub>Stg</sub>		-40 to +85		°C

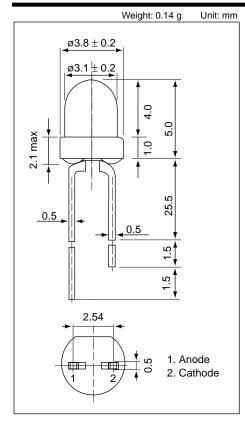
## Electro-Optical Characteristics ( $T_A = 25$ °C)

Ob	0	Test Condition	Red			Green				l lmit		
Characteristics	Symbol		Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	_	2.0	2.5	-	2.1	2.5	_	2.1	2.5	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	_	_	10	_	_	10	μA
Peak Emission Wavelength AND114(P) AND114S	λρ	I <sub>F</sub> = 20mA	_ _	700 625	_ _	_ _	565 -	_ _	_ _	590 –	_ _	nm
Spectral Line Half Width AND114(P) AND114S	λ	I <sub>F</sub> = 20mA	_ _	45 45	_ _	_ _	30 -	_ _	_ _	35 -	_ _	nm

#### Precaution

- 1. Soldering temperature: 260°C max; Soldering time: 3 sec. max; Soldering portion of lead: up to 2 mm from the body of the device.
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.





## **AND123 Series**

## Standard LED T-1 Package (3 mm)

#### **Features**

- Low power requirement
- Stand-off or flush-mount
- All plastic molded lens
- Choice of 3 colors: GaP-Red; GaP-Green; GaAsP-Yellow

#### Optical Characteristics (T = 25°C)

Part Number	Color		Lens	Axial Lu Intensit	minous y (mcd)	Test Condition	Viewing Angle
	LED	Lens	Desc.	Min.	Тур.	(I <sub>F</sub> -mA)	2 <del>0</del> 1/2 (deg)
AND123G	Green	Green	Clear	20	50	10	50
AND123R	Red	Red	Clear	5	12	10	50
AND123Y	Yellow	Yellow	Clear	10	45	10	50

## Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Characteristics	Symbol		Unit		
Characteristics	Symbol	Red	Red Green		Onit
Forward Current	I <sub>F</sub>	25	25	30	mA
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Power Dissipation	P <sub>D</sub>	120	105	105	mW
Operating Temperature Range	T <sub>Opr</sub>		°C		
Storage Temperature Range	T <sub>Stg</sub>		°C		

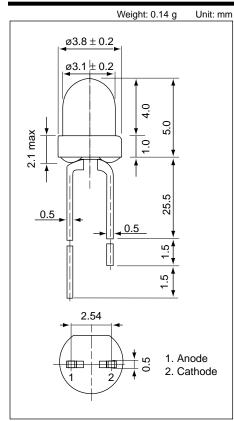
## Electro-Optical Characteristics $(T_A = 25^{\circ}C)$

Characteristics	Symbol	Sumbol Test		Red		Green				Unit		
		Condition	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	-	2.0	2.5	-	2.1	2.5	-	2.1	2.5	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	-	_	10	-	-	10	-	-	10	μA
Peak Emission Wavelength	λр	I <sub>F</sub> = 15mA	-	700	-	-	565	-	-	590	-	nm
Spectral Line Half Width	λ	I <sub>F</sub> = 15mA	-	45	-	-	30	-	-	35	-	nm

#### Precaution

- 1. Soldering temperature: 260°C max; Soldering time: 3 sec. max; Soldering portion of lead: up to 2 mm from the body of the device.
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.





## **AND124 Series**

## Standard LED T-1 Package (3 mm)

#### **Features**

- Low power requirement
- Stand-off or flush-mount
- · All plastic molded lens
- Choice of 3 colors: GaP Red; GaP Green; GaAsP Yellow

### Optical Characteristics (T = 25°C)

Part	Color		Lens	Axial Lu Intensit	minous y (mcd)	Test Condition	Viewing Angle
Number LED Lens	Desc.	Min.	Тур.	(I <sub>F</sub> –mA)	2θ1/2 (deg)		
AND124G	Green	Green	Diffused	8	20	10	60
AND124R	Red	Red	Diffused	1.3	3.0	10	60
AND124Y	Yellow	Yellow	Diffused	8	20	10	60

## Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Characteristics	Symbol		Unit		
Characteristics	Symbol	Red	Yellow		
Forward Current	I <sub>F</sub>	25	32	30	60
Reverse Voltage	V <sub>R</sub>	5	5	5	V
Power Dissipation	P <sub>D</sub>	120	105	105	mW
Operating Temperature Range	T <sub>Opr</sub>		°C		
Storage Temperature Range	T <sub>Stg</sub>		°C		

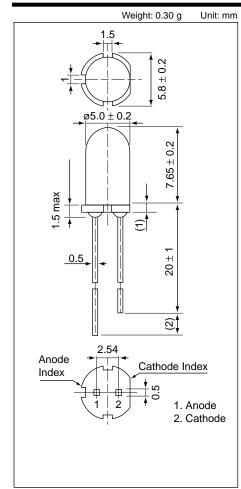
## Electro-Optical Characteristics (T<sub>A</sub> = 25°C)

Characteristics	Symbol	Test	Red		Green			Yellow			Unit	
Cital acteristics		Condition	Min.	Тур.	Max.	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	-	2.0	2.5	-	2.1	2.5	_	2.1	2.5	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	-	-	10	-	-	10	_	-	10	μA
Peak Emission Wavelength	λр	I <sub>F</sub> = 20mA	-	700	-	-	565	_	_	590	-	nm
Spectral Line Half Width	λ	I <sub>F</sub> = 15mA	_	45	_	_	30	_	_	35	-	nm

#### Precaution

- 1. Soldering temperature: 260°C max; Soldering time: 3 sec. max; Soldering portion of lead: up to 2 mm from the body of the device.
- 2. The lead can be formed up to 5 mm from the body of the device without forming stress. Soldering should be performed after the lead forming.





## AND181YP

## Standard LED T-1 3/4 Package (5 mm)

#### **Features**

- Low power requirement
- Stand-off or flush-mount
- All plastic molded lens
- Color: GaAsP-Yellow

#### Optical Characteristics (T = 25°C)

Color		Lens	Axial Luminous Intensity (mcd)		Test Condition	Viewing Angle
LED	Lens	Desc.	Min.	Тур.	(I <sub>F</sub> –mA)	201/2 (deg)
Yellow	Lt Yellow	Clear	75	150	20	15

## Absolute Maximum Ratings $(T_A = 25^{\circ}C)$

Characteristics	Symbol	Rating (Yellow)	Unit
Forward Current (DC)	I <sub>F</sub>	25	mA
Reverse Voltage	V <sub>R</sub>	4	V
Power Dissipation	P <sub>D</sub>	70	mW
Operating Temperature	T <sub>Opr</sub>	-20 to +75	°C
Storage Temperature Range	T <sub>Stg</sub>	-30 to +100	°C

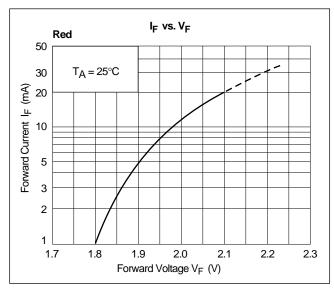
## Electro-Optical Characteristics (T<sub>A</sub> = 25°C)

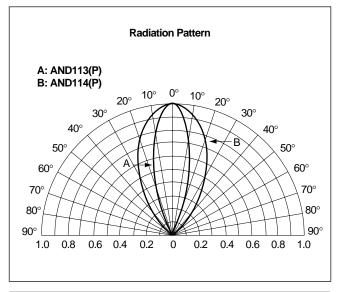
Characteristics	Symbol	Test Condition	Yellow			Unit
Characteristics			Min.	Тур.	Max.	Jilli
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20mA	-	2.1	2.8	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 4 V	-	-	100	μΑ
Peak Emission Wavelength	λр	I <sub>F</sub> = 15mA	-	585	-	nm
Spectral Line Half Width	λ	I <sub>F</sub> = 15mA	-	32	ı	nm

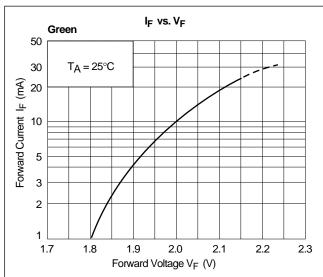
#### Precaution

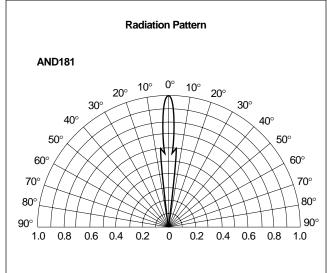
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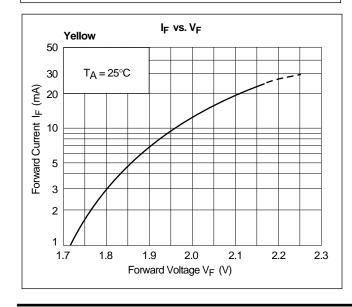


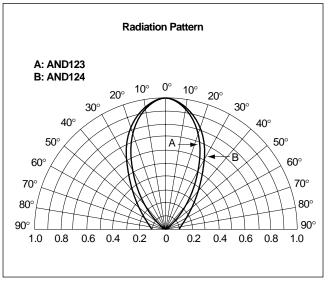




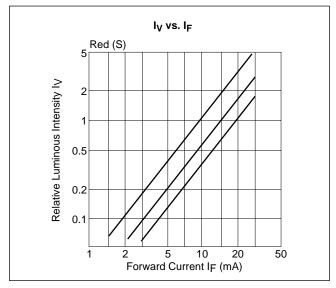


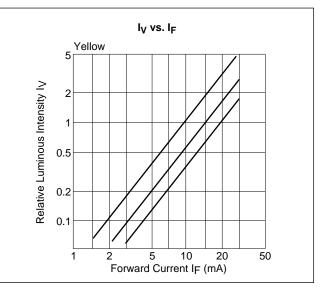


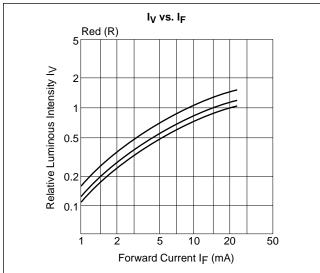


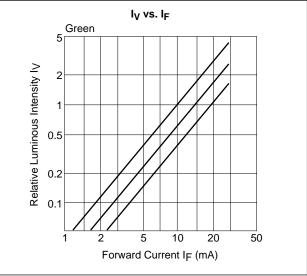












This graph shows relative luminous vs. forward current. At three points ( $I_F=10,15,20mA$ ) each relation is normalized.)



